

# M89 SERIES

Crystal Oscillator | 5.0V | CMOS | 5x7mm Gull Wing Leads\* | Military Grade



(4X) R 0.200

**Mechanical SPECIFICATIONS** 

0.276 ± .006

 $(7.0 \pm 0.2)$ 

	<b>Features</b>		Ruggediz
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- zed Design
  - **High-Shock & Vibration**
  - **Industry Standard Package**
  - ECCN EAR 99
- **Shortest Lead Time**
- **Smallest Hi-Rel Package**
- Radiation Tolerant to 30 krad TID
- **Best Stability Over Temperature**
- **Customer Support & Service**
- See M88 Datasheet for 3.3V Operation
- Robust, Rugged, High Shock Crystal Support (3 or 4 point Crystal Mount)

## **Electrical SPECIFICATIONS**

<b>Dash Nui</b> No TriState 1		Number With TriState	Frequency Range (MHz)	Supply Current @ 5.0V ±10% (mA)	Rise/Fall Time (tr/tf) max (nsec)	Symmetry min / max (%)	Aging per year max <u>1</u> / (ppm)	Stabilit -55°C to +150°C (ppm)	ty over Opera -55°C to +125°C (ppm)	ting Temper -55°C to +105°C (ppm)	-20°C to +70°C (ppm)
	CODE	CODE						CODE	CODE	CODE	CODE
	04	05	0.25 to 0.9	6	5	48/52	±5	±70	±50	±40	±25
	06	07	1 to 7.9	10	5	48/52	±5	±70	±50	±40	±25
	08	09	8.0 to 15.9	14	4	45/55	±5	±70	±50	±40	±25
	10	11	16 to 49.9	27	3	45/55	±5	±70	±50	±40	±25
	12	13	50 to 64.9	35	2	40/60	±5	±70	±50	±40	±25
	14	15	65 to 84.9	40	2	40/60	±5	±70	±50	±40	±25
	16	17	85 to 99.9	45	2	40/60	±5	±70	±50	±40	±25
	18	19	100 to 120	50	2	40/60	±5	±70	±50	±40	±25

Please Contact Us for Specification Options that are Outside of or beyond those Shown in the Table Above

### CMOS Output, 15 pF Load Output Voltage - Logic "0" is Vcc x 0.1 Vdc Output Voltage - Logic "1" is Vcc is 0.9 Vdc Start-up Time: 10 msec max

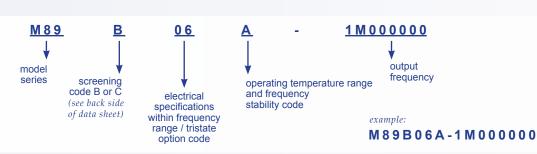
1/ Frequency Aging Limits	5 ppm per year	10 ppm per year
Max change over 30 days	±0.7 ppm	±1.5 ppm
Projected max change for 1 year after 30 days	±0.7 ppm	±1.5 ppm

#### Standard PIN CONFIGURATION

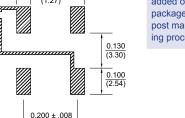
Pin Number	Function				
1	No Connect or TriState Enable				
2	Ground (case)				
3	Output				
4	Supply V (Vcc)				

# How To **ORDER**

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2008 Pb-free RoHS Certified



#### (R.008) Frequency standard Part Number 0.197 ± .006 marking FMI YYWW $(5.00 \pm 0.15)$ shown s/n 0.200 ± .008 $(5.08 \pm 0.2)$ 0.<u>110</u> max. (2.80) 0.028 ±0.003 (0.72) $0.060 \pm 0.004$ 0.018±.003 (0.46±0.08) $(1.52 \pm 0.08)$ 0.216 max (5.49) 0.008 3° to 5° typ. (0.203) 0.061± .005 detail A $(1.55 \pm 0.127)$ Leads are integral to the 0.25 ceramic header (6.35)They are not 0.05 (1.27) added on to the package in a post manufacturing process. 0.130 (3.30)



 $(5.08 \pm 0.2)$ An external bypass capacitor 0.01µF is required between Vdd and GND

dimensions:

inches / (mm)

Pad 1,

ESD Symbol



creening, B & C LEVEL		CO	_
Screening	Method Level:	В	
Non-Destruct Bond Pull	MIL-STD-883, Method 2023	•	
Internal Visual	MIL-STD-883, Method 2017, Class H; Method 2032, Class H	•	
Stabilization (Vacuum) Bake	MIL-STD-883, Method 1008, Condition C, 150°C, 24 hours min	•	
Temperature Cycling	MIL-STD-883, Method 1010, Condition B	•	
Constant Acceleration	MIL-STD-883, Method 2001, Condition A (Y1 only, 5000 g's)	•	T
Seal: Fine Leak	MIL-STD-883, Method 1014, Condition A1	•	
Seal: Gross Leak	MIL-STD-202, Method 112, Condition D	•	
Electrical Test	Functional Test Only	•	
Marking & Serialization	MIL-STD-1285	•	
Electrical Test	Nominal Vcc & Extremes and Nominal Temp and Extremes		
Burn-in (no-load)	+125°C, Nominal Supply Voltage and Burn-in load, 48 hours min		
Burn-in (load)	+125°C, Nominal Supply Voltage and Burn-in load, 160 hours min		
External Visual & Mechanical MIL-STD-883, Method 2009.10		•	
b) Frequency stability is test extremes and at +25°C at	uency, output waveform, are tested at +23°C ±2°C ed over the specified temperature range; at both a minimum of 5 temperature increments at a is by lot # and then serial #	•	

note: other screening levels and custom test plans available.





Other Leaded 5x7 mm Ceramic SMD for Military Applications, Please Inquire!

#### **Features**

- Ruggedized Design
- High-Shock & Vibration
- Made in the USA
- ECCN EAR 99
- Industry Standard Packages
- Highest Temperature Ranges
- Wider Frequency Ranges
- Higher Reliability
- Smaller Packages
- Lowest Current
- Best Service

# **Applications**

- Mobile and Stationary Systems
- Aircraft Engine
- Radar DSP
- Vision Systems
- Aircraft Control
- Position Sensors
- Drone

- Smart Ammunition
- Deep Space Robotic
- Navigation Systems
- Guidance Systems
- Short & Long Earth Orbit Missions
- Commercial Satellites
- Reusable Rockets

Environmental COMPLIANCE						
Environmental	Specification	Method Condition				
Vibration – Sine	MIL-STD-202	Method 204	Condition D	20g, 10 to 2 KHz		
Vibration – Random	MIL-STD-202	Method 214	Condition 1	30g rms, 10 to 2 KHz Random		
Shock	MIL-STD-202	Method 213	Condition I	100g, 6 ms, F:1500, 0.5 ms		
Seal Test	MIL-STD-883	Method 1014	Condition A1	Fine Leak		
Seal Test	MIL-STD-883	Method 1014	Condition C1	Gross Leak		
Temperature Cycling	MIL-STD-883	Method 1010	Condition B	10 Cycles Minimum		
Constant Acceleration	MIL-STD-883	Method 2001	Condition A	5000g, Y1 Axis		
Thermal Shock	MIL-STD-202	Method 107	Condition B			

## continued...

Environmental	Specification	Method	Condition
Ambient Pressure	MIL-STD-202	Method 105	Condition C
Resistance to Soldering Heat	MIL-STD-202	Method 210	Condition C
Moisture Resistance	MIL-STD-202	Method 106	with 7B Sub-cycle
Salt Atmosphere	MIL-STD-883	Method 1009	Condition A (24 hrs)
Terminal Strength	MIL-STD-202	Method 211	Test Condition D
Solderability	MIL-STD-883	Method 2003	
Resistance to Solvents	MIL-STD-202	Method 215	

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2008 Pb-free RoHS Certified

#### Military Reference Specifications

MIL-PRF-55310 Oscillators, Crystal Controlled, General Specification For
MIL-PRF-38534 Hybrid Microcircuits, General Specification For
MIL-STD-202 Test Method Standard, Electronic and Electrical Components
Test Methods and Procedures for Microelectronics
MIL-STD-1686 Electrostatic Discharge Control Program for Protection of

Electrical and Electronic Parts, Assemblies and Equipment

#### **Materials**

- Package Materials:
   Ceramic, Alumina 90% min
- 2. External Lead Plating Material: Gold plated Kovar, 0.15 μm (60 μ inch) min, over 2.0 μm (80 μ inch) min Nickel

#### **Products for Space Applications**

Contact us for assistance with your specification. We will provide you with the technical support and the required documentation.

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